

### General Description

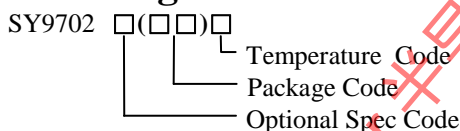
SY9702 is a wide input voltage range, high efficiency, fixed frequency buck-boost converter that operates from input voltage above, below or equal to the output voltage. It provides a power supply for system powered by either a two-cell or three-cell alkaline, Ni-Cd or Ni-MH battery, or a one-cell Li-Ion or Li-polymer battery.

SY9702 can support for 2A load current capability. It is based on a fixed frequency, pulse-width-modulation (PWM) controller using synchronous rectification to obtain maximum efficiency. The output voltage and compensation circuit can be programmed using external resistors and capacitors network. During shutdown, the load is disconnected from the battery. The device is packaged in tight QFN2x3-13.

### Features

- Fixed frequency operation with battery voltage above, below or equal to the output.
- Four internal power switches to form true 4-switches buck-boost with single inductor.
- Seamless buck-boost transition.
- 2.6V to 5.5V Input Voltage Range.
- 2A continuous output current capability.
- Output disconnect at shutdown.
- Power good indicator.
- Compact package: QFN2x3-13
- Built in thermal shut down protection, hard short protection.

### Ordering Information



Ordering Number	Package type	Note
SY9702QOC	QFN2x3-13	----

### Applications

- Palmtop Computers
- Handheld Instruments
- MP3/MP4 Players
- Digital Cameras/Camcorders
- Personal Medical Products
- High Power LED's
- All two-cell and three-cell alkaline, Ni-Cd or Ni-MH or signal-cell Li battery powered products

### Typical Applications

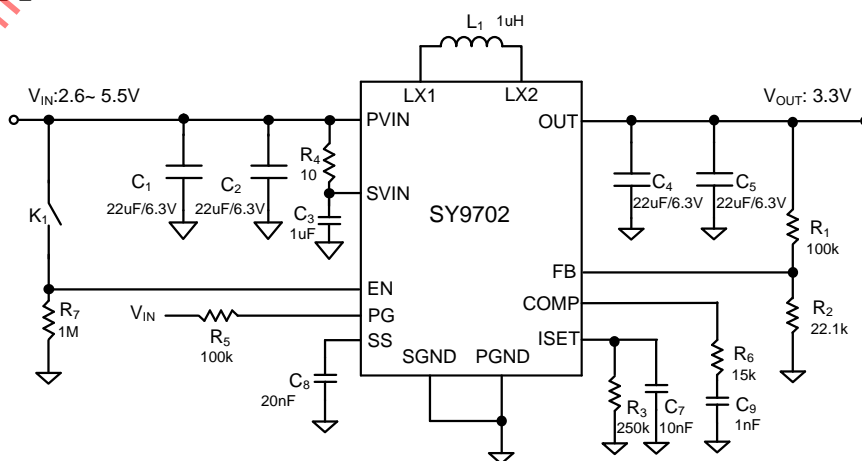
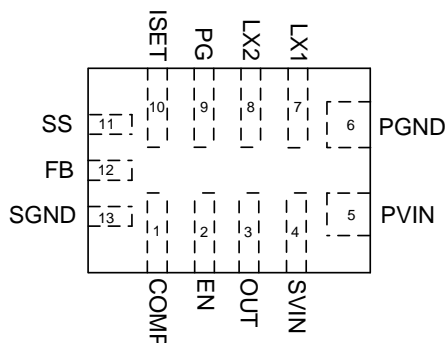


Figure 1. Schematic diagram

**Pinout (top view)**



**Top Mark: ZNxyz** (device code: ZN, x=year code, y=week code, z=lot number code)

Pin Name	Pin Number	Description
COMP	1	External compensation for voltage loop.
EN	2	Enable control. Pull high to turn on. Internal integrated with 1MΩ pull down Resistor.
OUT	3	Output of the synchronous rectifier. Decouple this pin to GND with at least 22uF ceramic cap. Minimize the loop area formed by output cap, OUT pin and GND paddles.
SVIN	4	Signal power input pin. Decouple this pin to GND with at least 1uF ceramic cap.
PVIN	5	Power input pin. Decouple this pin to GND with at least 22uF ceramic cap. Minimize the loop area formed by input cap, PVIN pin and GND paddles.
PGND	6	Power ground pin.
LX1	7	Inductor connection 1 Connect this node to the switching node of the inductor.
LX2	8	Inductor connection 2. Connect this node to the switching node of the inductor.
PG	9	Power good indicator.
ISET	10	Apply a resistor and capacitor parallel network to sense the output average current. If V <sub>ISET</sub> is lower than 0.2V, IC will go into PFM mode. Do not let it floating. Tie to ground for forced PWM operation.
SS	11	Connect this pin to a soft-start capacitor to program soft-start time.
FB	12	Output feedback pin. Connect this pin to the center point of the output resistor divider to program the output voltage.
SGND	13	Signal ground pin.

**Absolute Maximum Ratings (Note 1)**

OUT	4 V
All Other Pins	6V
Power Dissipation, P <sub>D</sub> @ T <sub>A</sub> = 25°C	3W
Package Thermal Resistance (Note 2)	
θ <sub>JA</sub>	40°C/W
θ <sub>JC</sub>	18°C/W
Junction Temperature Range	150°C



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Lead Temperature (Soldering, 10 sec.) ----- 260°C  
Storage Temperature Range ----- -65°C to 150°C

**Recommended Operating Conditions** (Note 3)

Supply Input Voltage ----- 2.6V to 5.5V  
Output Voltage ----- 2.6V to 3.8V  
Junction Temperature Range ----- -40°C to 125°C  
Ambient Temperature Range ----- -40°C to 85°C

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## Electrical Characteristics

( $V_{IN} = 4.2V$ ,  $V_{OUT} = 3.3V$ ,  $L = 1\mu H$ ,  $C_{OUT} = 22\mu F \times 2$ ,  $T_A = 25^\circ C$ ,  $I_{OUT} = 1A$  unless otherwise specified)

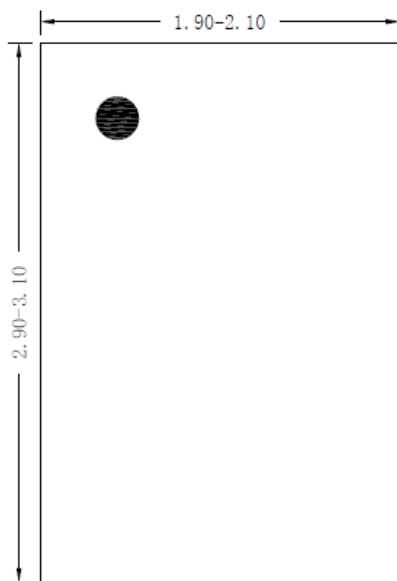
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Input Voltage Range	$V_{IN}$		2.6		5.5	V
Output Voltage Range	$V_{OUT}$		2.6		3.8	V
Quiescent Current	$I_Q$	$I_{OUT}=0$ , $EN=1$ , $ISET=250k\Omega$ , $FB=105\% * V_{REF}$		60	100	$\mu A$
Shutdown Current	$I_{SHDN}$	$EN=0$		0.1	1	$\mu A$
Feedback Reference Voltage	$V_{REF}$		0.591	0.6	0.609	V
NFET $R_{DS(ON)}$	$R_{DS(ON)1}$			50		$m\Omega$
PFET $R_{DS(ON)}$	$R_{DS(ON)2}$			50		$m\Omega$
Input Peak Current Limit	$I_{LIM}$		4.5	5		A
Output Negative Current Limit	$I_{NEG}$			-1		A
Soft-start current	$I_{SS}$	Soft-start time: $t_{ss} = \frac{0.7V}{I_{SS}} \times C_{ss}$		5		$\mu A$
EN rising threshold	$V_{ENH}$		1.5			V
EN falling threshold	$V_{ENL}$				0.4	V
Input UVLO rising threshold	$V_{UVLO}$			2.45	2.55	V
UVLO hysteresis	$V_{HYS}$			0.2		V
PG rising threshold	$V_{FB,HV}$			0.48		V
PG under-voltage threshold	$V_{FB,LV}$			0.48		V
PG over voltage threshold	$V_{FB,OV}$			0.72		V
Output current sense	$ISET$	$I_{OUT}=1A$		5		$\mu A$
Output Voltage Over Protection	$V_{OVP}$			125		%
OVP protection delay time	$T_{OVP\_delay}$			16		$\mu s$
ISET pin threshold for PFM mode	$V_{PFM}$			0.2		V
Oscillator Frequency	$F_{OSC}$	$I_{OUT}=1.0A$	0.8	1.0	1.2	MHz
Min Duty Cycle		Boost & Buck		10		%
Max Duty Cycle		Boost & Buck		90		%
Thermal Shutdown Temperature	$T_{SD}$			150		$^\circ C$
Thermal Shutdown Hysteresis	$T_{HYS}$			15		$^\circ C$

**Note 1:** Stresses beyond the “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

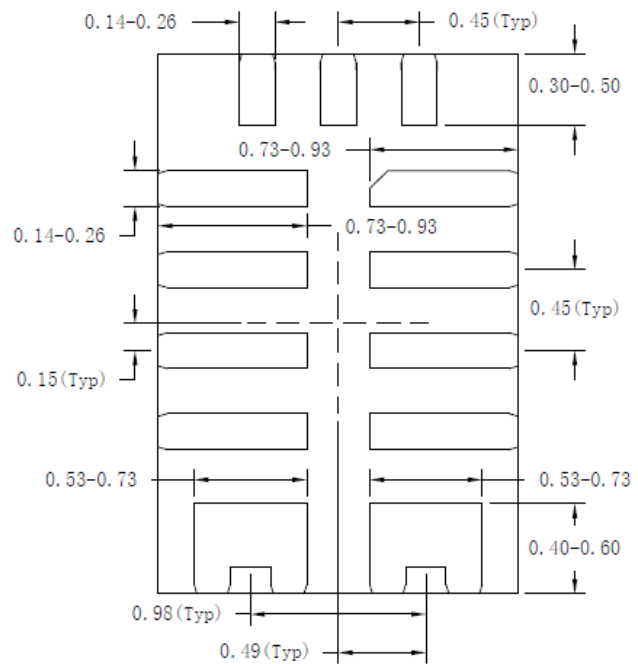
**Note 2:**  $\theta_{JA}$  is measured in the natural convection at  $T_A = 25^\circ C$  on a low effective single layer thermal conductivity test board of JEDEC 51-3 thermal measurement standard. Paddle of QFN2x3-13 package is the case position for  $\theta_{JC}$  measurement.

**Note 3:** The device is not guaranteed to function outside its operating conditions.

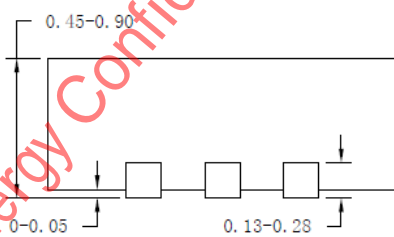
## QFN2x3-13 Package Outline Drawing



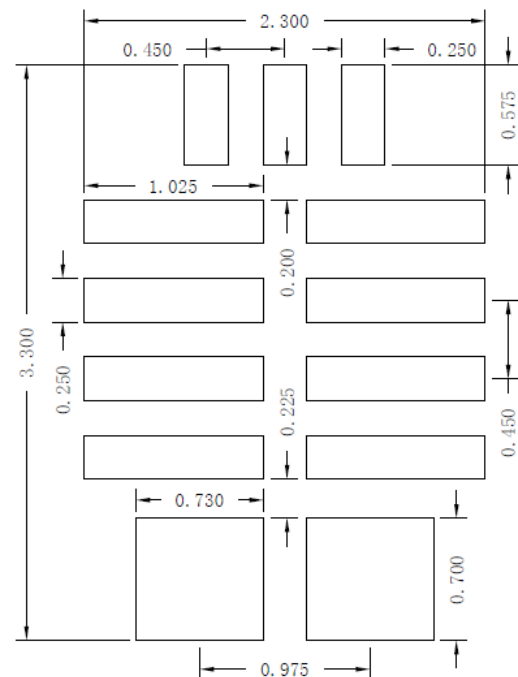
**Top View**



**Bottom View**



**Side View**

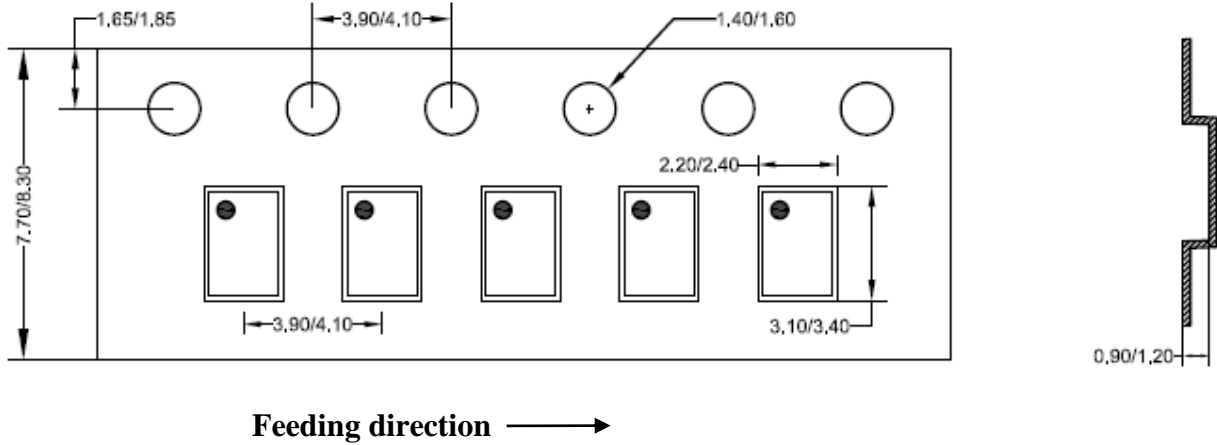


**Recommended PCB layout  
(Reference Only)**

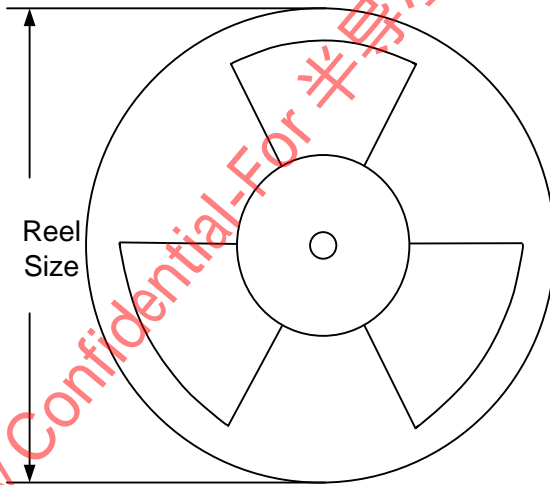
**Notes: All dimension in millimeter and exclude mold flash & metal burr.**

**Taping & Reel Specification**

**1. QFN2x3-13 taping orientation**



**2. Carrier Tape & Reel specification for packages**



Package type	Tape width (mm)	Pocket pitch(mm)	Reel size (Inch)	Trailer length(mm)	Leader length (mm)	Qty per reel
QFN2x3	8	4	7"	400	160	3000

**3. Others: NA**